

Silicon Carbide (SiC) Schottky Diode - EliteSiC, 6 A, 650 V, D2, DPAK

FFSD0665B

Silicon Carbide (SiC) Schottky Diodes use a completely new technology that provides superior switching performance and higher reliability compared to Silicon. No reverse recovery current, temperature independent switching characteristics, and excellent thermal performance sets Silicon Carbide as the next generation of power semiconductor. System benefits include highest efficiency, faster operating frequency, increased power density, reduced EMI, and reduced system size and cost.

Features

- Max Junction Temperature 175°C
- Avalanche Rated 24.5 mJ
- High Surge Current Capacity
- Positive Temperature Coefficient
- Ease of Paralleling
- No Reverse Recovery/No Forward Recovery
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

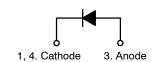
Applications

- · General Purpose
- SMPS, Solar Inverter, UPS
- Power Switching Circuits

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage	V_{RRM}	650	V	
Single Pulse Avalanche Energy ($I_{L(pk)} = 9.9 \text{ A}, L = 0.5 \text{ mH}, V = 50 \text{ MH}$	E _{AS}	24.5	mJ	
Continuous Rectified Forward Current	T _C < 154	ΙF	6.0	Α
Current	T _C < 135		9.1	
Non-Repetitive Peak Forward Surge Current	$T_C = 25$ °C, $t_P = 10 \mu$ s	I _{FM}	493	Α
	$T_{C} = 150^{\circ}C,$ $t_{P} = 10 \ \mu s$		442	
Non-Repetitive Forward Surge Current (Half-Sine Pulse)	$T_{C} = 25^{\circ}C$ $t_{P} = 8.3 \text{ ms}$	I _{FSM}	28	Α
Power Dissipation	T _C = 25°C	P _{tot}	75	W
	T _C = 150°C		12.5	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



Schottky Diode



DPAK CASE 369AS

MARKING DIAGRAM



A YWW ZZ Assembly Plant CodeDate Code (Year & Week)

= Lot Code

FFSD0665B = Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

FFSD0665B

THERMAL RESISTANCE

Parameter		Value	Unit
Thermal Resistance, Junction-to-Case		2.0	°C/W

ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Test Conditions Min		Тур	Max	Unit
N CHARAC	TERISTICS		•	•	•	
V _F	Forward Voltage	I _F = 6.0 A, T _J = 25°C		1.38	1.7	V
		I _F = 6.0 A, T _J = 125°C		1.53	2.0	1
		I _F = 6.0 A, T _J = 175°C		1.67	2.4	1
I _R	Reverse Current	V _R = 650 V, T _J = 25°C		0.5	40	μΑ
		V _R = 650 V, T _J = 125°C		1.0	80	1
		V _R = 650 V, T _J = 175°C		2.0	160	1
HARGES, C	APACITANCES & GATE RES	ISTANCE				
Q_{C}	Total Capacitive Charge	V _C = 400 V		16		nC
C _{tot}	7	V _R = 1 V, f = 100 kHz		259		pF
		V _R = 200 V, f = 100 kHz		29		1
		V _R = 400 V, f = 100 kHz		22		1

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

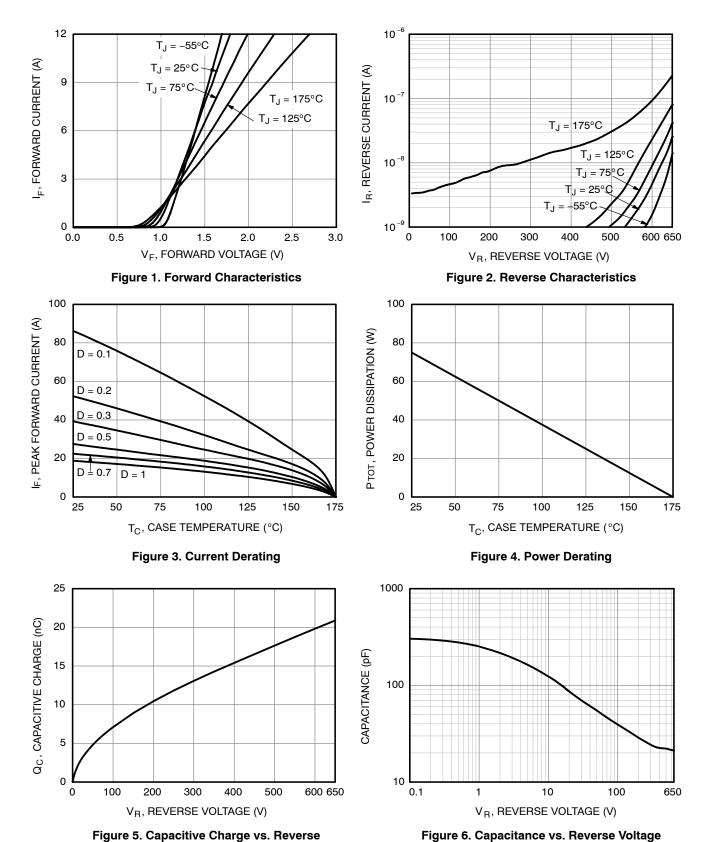
PART MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method [†]	Reel Size	Tape Width	Quantity
FFSD0665B	FFSD0665B	DPAK	Tape & Reel	330 mm	16 mm	2500 units

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

FFSD0665B

TYPICAL CHARACTERISTICS



Voltage

FFSD0665B

TYPICAL CHARACTERISTICS (CONTINUED)

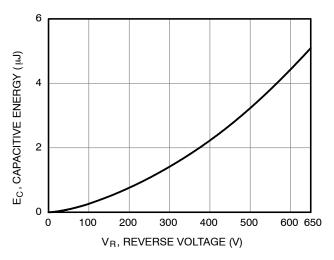


Figure 7. Capacitance Stored Energy

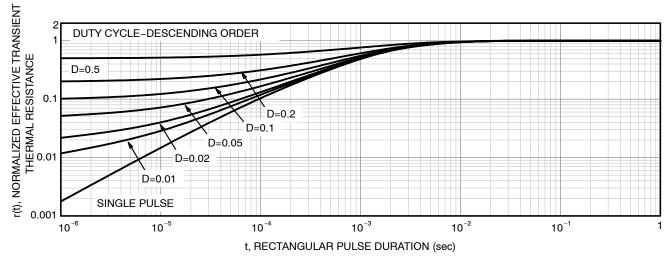


Figure 8. Junction-to-Case Transient Thermal Response





DPAK3 6.10x6.54x2.29, 4.57P CASE 369AS **ISSUE B**

DATE 20 DEC 2023

- NOTES: UNLESS OTHERWISE SPECIFIED

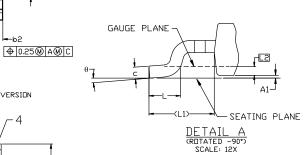
 A) THIS PACKAGE CONFORMS TO JEDEC, TO-252, ISSUE F, VARIATION AA.

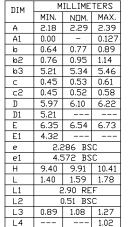
 B) ALL DIMENSIONS ARE IN MILLIMETERS.

 C) DIMENSIONING AND TOLERANCING PER

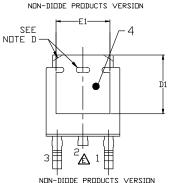
 - D>

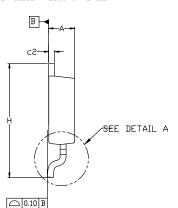
- A
- F)
- DIMENSIONING AND TOLERANCING PER
 ASME Y14.5M-2018.
 SUPPLIER DEPENDENT MOLD LOCKING HOLES OR CHAMFERED
 CORNERS OR EDGE PROTRUSION.
 FOR DIGDE PRODUCTS, L4 IS 0.25 MM MAX PLASTIC BODY
 STUB WITHOUT CENTER LEAD.
 DIMENSIONS ARE EXCLUSIVE OF BURRS,
 MOLD FLASH AND TIE BAR EXTRUSIONS.
 LAND PATTERN RECOMMENDATION IS BASED ON IPC7351A STD
 T0228P991X239-3N.

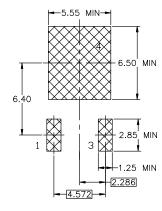




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LAND PATTERN RECOMMENDATION

*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

GENERIC MARKING DIAGRAM*

10°

XXXXXX XXXXXX **AYWWZZ**

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

XXXX = Specific Device Code

= Assembly Location Α

Υ = Year

WW = Work Week

77 = Assembly Lot Code

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